

## CURRENT SENSOR

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PRODUCT SERIES: SFG-X.XP/P4

PRODUCT PART NUMBER: SFG-3.0P/P4,  
SFG-5.0P/P4

Version: Ver 1.0



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## 1. Description

### Features

- Closed loop (compensated) current transducer
- Voltage output
- Insulation voltage for 5 kVAC
- Single supply voltage
- PCB mounting.

### Advantages

- High accuracy
- High overload capability
- High insulation capability
- High separation ability
- Low temperature drift
- Degauss and test functions

### Applications

- Residual current measurement
- Leakage current measurement in PV inverters
- First human contact protection of PV arrays
- Failure detection in power sources
- Leakage current detection in stacked DC sources
- Communication power.

## 2. Absolute parameter: SFG-X.XP/P4

### Absolute maximum ratings

Parameter	Symbol	Unit	Value
Maximum Supply voltage	$V_{C \max}$	V	7
Maximum Primary conductor temperature	$T_{B \max}$	°C	110
Maximum overload capability (100 $\mu$ s, 500 A/ $\mu$ s)	$\hat{I}_{P \max}$	A	3300
Maximum Voltage between test winding and secondary pins	$V_{d \max}$	V	35
Maximum Current of test winding	$I_{T \max}$	mA	300

### Ratings

Parameter	Symbol	Unit	Value
Primary involved potential		V AC/DC	1000
Primary current @ $T_{A \max}=105^{\circ}\text{C}$	$I_P$	A	220
Primary current @ $T_{A \max}=85^{\circ}\text{C}$	$I_P$	A	250
Secondary supply voltage	$U_C$	V DC	5
Output voltage	$V_{out}$	V	0 to 5

### Isolation parameters

Parameter	Symbol	Unit	Value	Remark
RMS voltage for AC	$V_d$	kV	4	test 50 Hz/1 min
Impulse withstand voltage	$V_w$	kV	10.1	1.2/50 $\mu$ s
Clearance distance (pri. –pri.)	$d_{Cl}$	mm	11	Shortest distance through air
Creepage distance (pri. – pri.)	$d_{Cp}$	mm	16	Shortest path along device body
Clearance distance (pri. –sec.)	$d_{Cl}$	mm	12.1	When mounted on PCB with recommended layout
Creepage distance (pri. –sec.)	$d_{Cp}$	mm	12.1	When mounted on PCB with recommended layout
Comparative tracking index	CTI	V	600	
Application example		V	600 CAT III, PD2	Reinforced insulation, non uniform field
Application example		V	1500 CAT III, PD2	Basic insulation, non uniform field

### Environmental and mechanical characteristics

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Ambient operating temperature	$T_A$	°C	-40		85	
Ambient storage temperature	$T_S$	°C	-40		105	
Mass	$m$	g		300		
standard	EN 50178, IEC 61010, UL 508					

### 3. Electrical data: SFG-3.0P/P4

At  $T_A = 25\text{ }^\circ\text{C}$ ,  $V_C = 5\text{ V}$ .

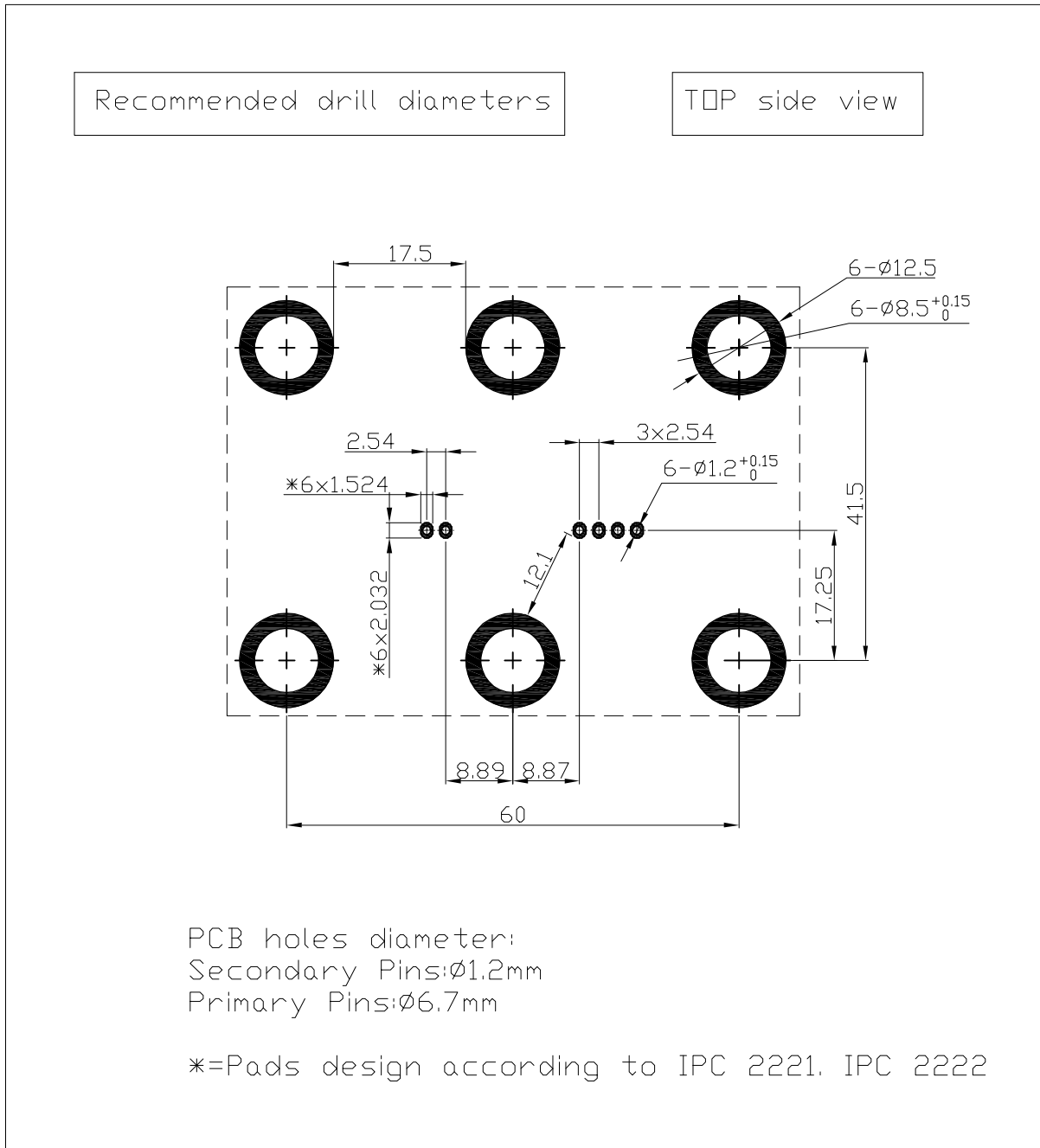
Parameters	Symbol	Unit	Min	Typ	Max	Remark
Primary nominal residual rms current	$I_{PN}$	A		3		
Primary residual current, measuring range	$I_{PM}$	A	-5		5	
Supply voltage	$V_C$	V	4.75	5	5.5	
Current consumption	$I_C$	mA		17.5	21.6	$I_P(\text{mA}) / N_a$ $N_a = 1000\text{ turns}$ - $40\text{ }^\circ\text{C} \dots 105\text{ }^\circ\text{C}$
Reference voltage @ $I_P = 0$	$V_{ref}$	V	2.495	2.5	2.505	Internal reference
External reference voltage	$V_{REF}$	V	2.3		4	Internal reference of $V_{ref}$ input = $499\ \Omega$
Electrical offset current referred to primary	$I_{OE}$	mA	-24	7	24	
Temperature coefficient of VOE @ $I_P = 0$	$TCV_{OE}$	ppm/K			570	ppm/K of 2.5 V - $40 \dots 105\text{ }^\circ\text{C}$
Theoretical sensitivity	$G_{th}$	V/A		0.4		
Sensitivity error	$\epsilon_G$	%	-1.6	0.5	1.6	$R_L > 500\text{ k}\Omega$
Temperature coefficient of G	$TCG$	ppm/K		$\pm 400$		- $40\text{ }^\circ\text{C} \dots 105\text{ }^\circ\text{C}$
Linearity error	$\epsilon_L$	%		0.5	1	
Number of turns (test winding)	$N_T$			20		$R_L > 500\text{ k}\Omega$ , $di/dt > 5\text{ A}/\mu\text{s}$
Reaction time @ 10 % of $I_{PRN}$	$t_{ra}$	$\mu\text{s}$		5		$R_L > 500\text{ k}\Omega$ , $di/dt > 5\text{ A}/\mu\text{s}$
Step response time to 90 % of $I_{PN}$	$t_r$	$\mu\text{s}$		40		$R_L > 500\text{ k}\Omega$
Frequency bandwidth (-3dB)	$BW$	kHz		15		$R_L > 500\text{ k}\Omega$
Noise(1 Hz ~ 10 kHz)	$V_{no}$	mV rms		10		
Accuracy@ $I_{PN}$ @ $T_A = 25\text{ }^\circ\text{C}$	$X_{25\text{ }^\circ\text{C}}$	% of $I_{PN}$		$\pm 1.9$		
Accuracy@ $I_{PN}$ @ $T_A = 105\text{ }^\circ\text{C}$	$X_{105\text{ }^\circ\text{C}}$	% of $I_{PN}$		$\pm 3.2$		

#### 4. Electrical data: SFG-5.0P/P4

At  $T_A = 25\text{ }^\circ\text{C}$ ,  $V_C = 5\text{ V}$ .

Parameters	Symbol	Unit	Min	Typ	Max	Remark
Primary nominal residual rms current	$I_{PN}$	A		5		
Primary residual current, measuring range	$I_{PM}$	A	-8		8	
Supply voltage	$V_C$	V	4.75	5	5.5	
Current consumption	$I_C$	mA		17.5	21.6	$I_P(\text{mA}) / N_a$ $N_a = 1000\text{ turns}$ - $40\text{ }^\circ\text{C} \dots 105\text{ }^\circ\text{C}$
Reference voltage @ $I_P = 0$	$V_{ref}$	V	2.495	2.5	2.505	Internal reference
External reference voltage	$V_{REF}$	V	2.3		4	Internal reference of $V_{ref}$ input = $499\ \Omega$
Electrical offset current referred to primary	$I_{OE}$	mA	-35	12	35	
Temperature coefficient of VOE @ $I_P = 0$	$TCV_{OE}$	ppm/K			570	ppm/K of 2.5 V - $40 \dots 105\text{ }^\circ\text{C}$
Theoretical sensitivity	$G_{th}$	V/A		0.2		
Sensitivity error	$\epsilon_G$	%	-1.6	0.5	1.6	$R_L > 500\text{ k}\Omega$
Temperature coefficient of G	$TCG$	ppm/K		$\pm 400$		- $40\text{ }^\circ\text{C} \dots 105\text{ }^\circ\text{C}$
Linearity error	$\epsilon_L$	%		0.5	1	
Number of turns (test winding)	$N_T$			20		$R_L > 500\text{ k}\Omega$ , $di/dt > 5\text{ A}/\mu\text{s}$
Reaction time @ 10 % of $I_{PRN}$	$t_{ra}$	$\mu\text{s}$		5		$R_L > 500\text{ k}\Omega$ , $di/dt > 5\text{ A}/\mu\text{s}$
Step response time to 90 % of $I_{PN}$	$t_r$	$\mu\text{s}$		40		$R_L > 500\text{ k}\Omega$
Frequency bandwidth (-3dB)	$BW$	kHz		15		$R_L > 500\text{ k}\Omega$
Noise(1 Hz ~ 10 kHz)	$V_{no}$	mV rms		10		
Accuracy@ $I_{PN}$ @ $T_A = 25\text{ }^\circ\text{C}$	$X_{25\text{ }^\circ\text{C}}$	% of $I_{PN}$		$\pm 1.9$		
Accuracy@ $I_{PN}$ @ $T_A = 105\text{ }^\circ\text{C}$	$X_{105\text{ }^\circ\text{C}}$	% of $I_{PN}$		$\pm 3.2$		

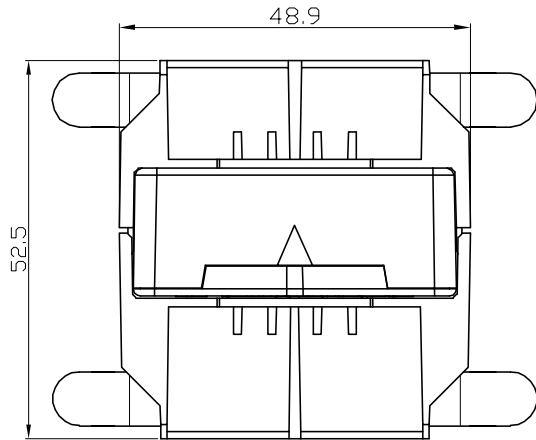
## 5. SFG- P/P4 PCB footprint



### Assembly on PCB

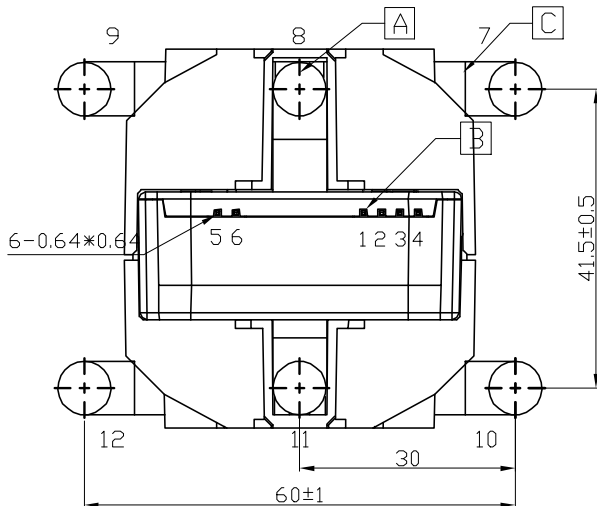
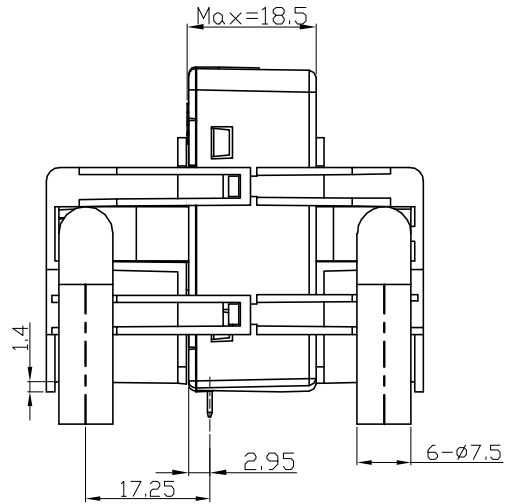
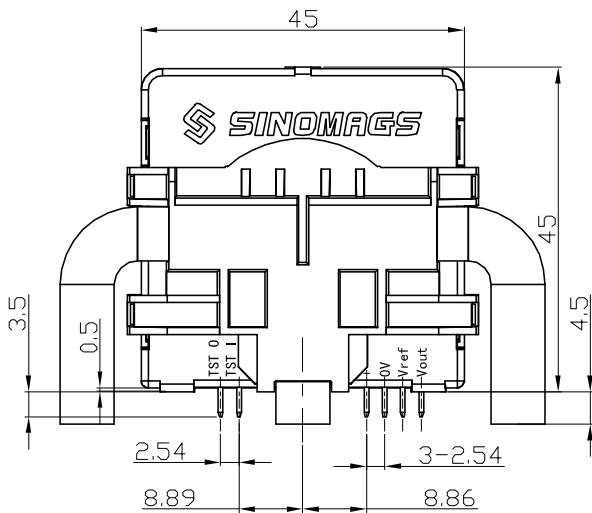
- No Primary in shadow area
- Maximum PCB thickness 2.4 mm
- Wave-soldering: 260°C @ 10 s
- Recommended PCB hole diameter 1.2 mm for secondary pin.

## 6. SFG- P/P4 Dimensions



Terminals:

1	2	3
Vcc	GND	Vref
4	5	6
Vout	Test Out	Test In
7	8	9
I <sub>p+</sub>	I <sub>p+</sub>	I <sub>p+</sub>
10	11	12
I <sub>p-</sub>	I <sub>p-</sub>	I <sub>p-</sub>



	$d_{CI}$	$d_{CP}$
A-B	15.3mm	---
A-C	11mm	16mm
C-D	16.0mm	16.0mm

D is secondary inside the transducer

On the customer's PCBA		
	$d_{CI}$	$d_{CP}$
A-B	12.1mm	12.1mm
A-C	11mm	17.5mm

Material : Fit UL94V-0 & RoHS requirements ;

General tolerance :  $\pm 0.5$

Unit : mm

